TOSHIBA Transistor Silicon PNP Epitaxial Type (PCT Process)

## HN4A56JU

### Audio Frequency General Purpose Amplifier Applications

- Small Package (Dual Type)
- High Voltage and High Current

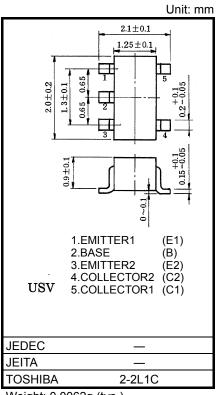
:  $V_{CEO} = -50V$ ,  $I_C = -150mA(MAX.)$ 

- High h<sub>FF</sub>
- Excellent h<sub>FE</sub> Linearity

:  $h_{FE} (I_C = -0.1 \text{mA}) / h_{FE} (I_C = -2 \text{mA}) = 0.95 \text{ (typ.)}$ 

# Absolute Maximum Ratings (Ta = 25°C) (Q1, Q2 Common)

Characteristic	Symbol	Rating	Unit
Collector-base voltage	$V_{CBO}$	-50	V
Collector-emitter voltage	V <sub>CEO</sub>	-50	V
Emitter-base voltage	V <sub>EBO</sub>	-5	V
Collector current	IC	-150	mA
Base current	ΙΒ	-30	mA
Collector power dissipation	Pc*	200	mW
Junction temperature	Tj	150	°C
Storage temperature range	T <sub>stg</sub>	-55~150	°C



Weight: 0.0062g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high

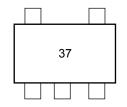
temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

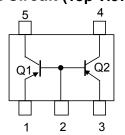
#### Electrical Characteristics (Ta = 25°C) (Q1,Q2 Common)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	_	$V_{CB} = -50V$ , $I_E = 0$	_	_	-0.1	μA
Emitter cut-off current	I <sub>EBO</sub>	_	$V_{EB} = -5V, I_{C} = 0$		_	-0.1	μA
DC current gain	h <sub>FE</sub>	_	$V_{CE} = -6V, I_{C} = -2mA$	120	_	400	
Collector-emitter saturation voltage	V <sub>CE</sub>	_	I <sub>C</sub> = -100mA, I <sub>B</sub> = -10mA	_	-0.1	-0.3	V
Transition frequency	f <sub>T</sub>	_	$V_{CE} = -10V, I_{C} = -1mA$	60	_	_	MHz
Collector output capacitance	C <sub>ob</sub>	_	$V_{CB} = -10V$ , $I_{E} = 0$ , $f = 1MHz$	_	4	_	pF

#### Marking

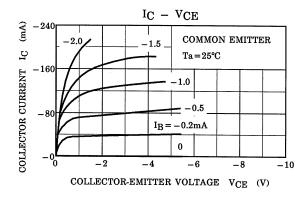


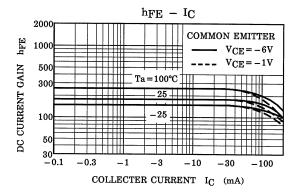
#### **Equivalent Circuit (Top View)**

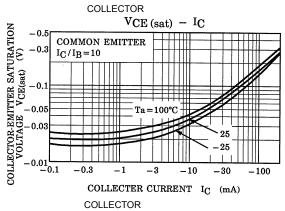


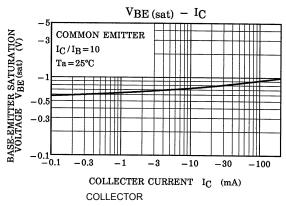
<sup>\*</sup>Total rating: Power dissipation per element should not exceed 130mW.

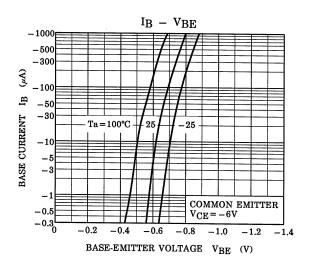
(Q1, Q2 Common)

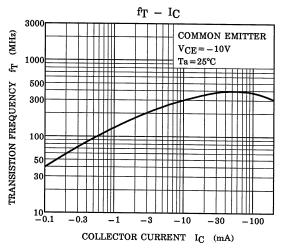


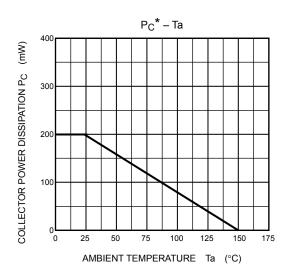












\*:Total Rating

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